

EGPL-G102

M.2 to Single Isolated
GbE LAN Module

Customer: _____

Customer _____

Part Number: _____

Innodisk _____

Part Number: _____

Innodisk _____

Model Name: _____

Date: _____

Innodisk Approver	Customer Approver

Table of Contents

TABLE OF CONTENTS	I
REVISION HISTORY	II
LIST OF TABLES	1
LIST OF FIGURES	2
1. PRODUCT INTRODUCTION	3
1.1. OVERVIEW	3
1.2. FEATURES	3
2. PRODUCT SPECIFICATIONS	4
2.1. DEVICE PARAMETERS	4
2.2. ELECTRICAL SPECIFICATIONS.....	5
2.2.1.POWER REQUIREMENT.....	5
2.2.2.POWER CONSUMPTION	5
2.3. ENVIRONMENTAL SPECIFICATIONS	5
2.3.1.TEMPERATURE RANGES.....	5
2.3.2.HUMIDITY	5
2.3.3.SHOCK AND VIBRATION	5
2.3.4.MEAN TIME BETWEEN FAILURE (MTBF)	5
2.4. CE AND FCC COMPATIBILITY.....	6
2.5. RoHS COMPLIANCE	6
2.6. HARDWARE.....	7
2.6.1.LAYOUT.....	7
2.6.2.PIN DEFINE	8
2.6.3.I/O CONNECTOR MECHANICAL DRAWING & PIN DEFINES	9
2.6.4.EGPL-G102 MECHANICAL DRAWING	11
2.6.5.CABLE MECHANICAL DRAWING.....	12
2.6.6.PACKING LIST	12
2.7. SOFTWARE SUPPORT.....	12
3. INSTALLATION GUIDE	13
4. APPENDIX	14
CONTACT US	18

REVISION HISTORY

Revision	Description	Date
1.0	First Released	Feb , 2022

List of Tables

TABLE 1: DEVICE PARAMETERS	4
TABLE 2: POWER REQUIREMENT.....	5
TABLE 3: POWER CONSUMPTION	5
TABLE 4: TEMPERATURE RANGES.....	5
TABLE 5: SHOCK AND VIBRATION	5
TABLE 6: MEAN TIME BETWEEN FAILURE (MTBF).....	6
TABLE 7: M.2 2242 PCB LAYOUT LEGEND.....	7
TABLE 8: DAUGHTER BOARD PCB LAYOUT LEGEND	7
TABLE 9: M.2 B-M KEY PIN DEFINE.....	8
TABLE 10: WIRE TO BOARD SMD 2*10P CONNECTOR PIN DEFINE.....	9
TABLE 11: RJ45 LAN LED TABLE.....	11

List of Figures

FIGURE 1: BLOCK DIAGRAM	3
FIGURE 2: M.2 2242 BOARD PICTURE.....	4
FIGURE 3: MOUNTING HOLE, DAUGHTER BOARD PICTURE	4
FIGURE 4: WIRE TO BOARD SMD 2*10P CONNECTOR DRAWING	9
FIGURE 5: RJ45 CONNECTOR DRAWING	10
FIGURE 6: EGLP-G102 M.2 BOARD DRAWING	11
FIGURE 7: MOUNTING HOLE DAUGHTER BOARD DRAWING.....	11
FIGURE 8: BOARD TO BOARD LAN CABLE DRAWING.....	12

1. Product Introduction

1.1. Overview

Innodisk EGLP-G102 is designed with M.2 2242 B/M key form factor, EGLP-G102 supports PCIe Gen 2.1 with a single lane to single independent isolated GbE LAN, optimized for higher performance and lower power, which brings you a flexible expansion solution for embedded systems.

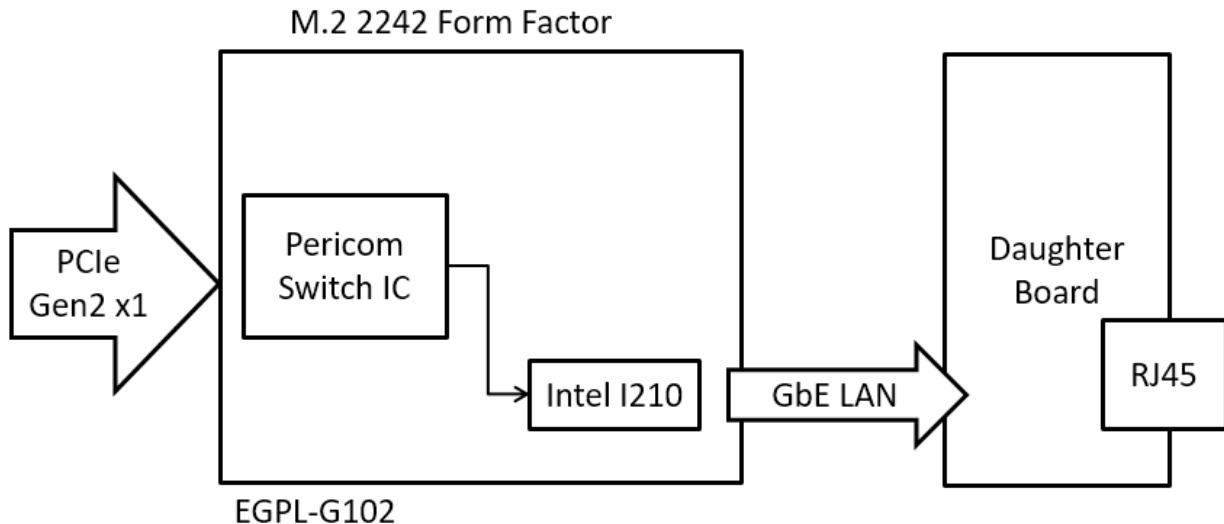


Figure 1: Block Diagram

1.2. Features

- Single isolated GbE LAN port
- Complies with EN61000-4-5 2kV surge protection
- Complies with IEC 60950-1:2005 + A1: 2009 +A2:2013 2kV HiPOT protection
- Complies with EN61000-4-2 (ESD) Air-15kV, Contact-8kV
- Flexible daughter board with cable to fit into different system
- Industrial temperature -40 °C to 85 °C

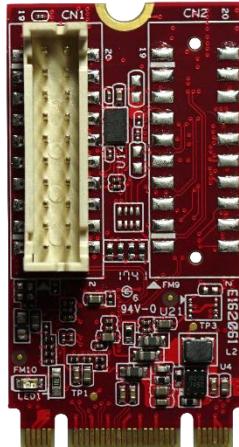


Figure 2: M.2 2242 Board Picture

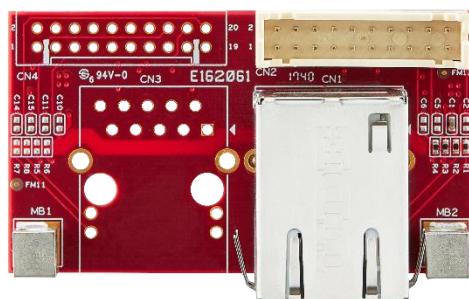


Figure 3: Mounting Hole, Daughter Board Picture

2. Product Specifications

2.1. Device Parameters

Table 1: Device Parameters

Form Factor	M.2 2242 B-M
Input I/F	PCI Express 2.1 x 1
Output I/F	GbE LAN x 1
Output Connector	RJ45 x 1
Dimension (WxLxH)	M.2 Board: 22 x 42 x 9.15 mm Daughter Board: 50 x 28 x 19.37 mm

2.2. Electrical Specifications

2.2.1. Power Requirement

Table 2: Power Requirement

Item	Connector	Rating
Input voltage	M.2 Golden Finger	+3.3 VDC +-5%

2.2.2. Power Consumption

Table 3: Power Consumption

Full Load (mA)	Voltage (V)
675	3.3

2.3. Environmental Specifications

2.3.1. Temperature Ranges

Table 4: Temperature Ranges

Temperature	Range
Operating	Standard Grade: 0°C to +70°C Industrial Grade: -40°C to +85°
Storage	-55°C to +95°

2.3.2. Humidity

Relative Humidity: 10-95%, non-condensing

2.3.3. Shock and Vibration

Table 5: Shock and Vibration

Reliability	Test Conditions	Reference Standards
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 68-2-6
Mechanical Shock	Duration: 0.5ms, 1500 G, 3 axes	IEC 68-2-27

2.3.4. Mean Time between Failure (MTBF)

Reliability prediction methodology provides the basis for reliability evaluation and analysis. The purpose of the prediction is to predict the life time of the product in units of failure rate and MTBF.

Table 6: Mean Time between Failure (MTBF)

Product	Condition	MTBF (Hours)
EGPL-G102	The analysis is at 25°C ambient temperature by Telcordia SR-332, Issues 4, Method I, Case 3 under Ground Benign, Controlled environment, 50% operation stress	TBD

2.4. CE and FCC Compatibility

EGPL-G102 conforms to CE and FCC requirements.

2.5. RoHS Compliance

EGPL-G102 is fully compliant with RoHS directive.

2.6. Hardware

2.6.1. Layout

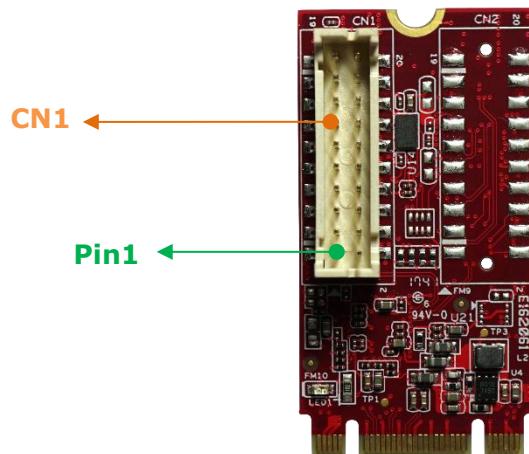


Table 7: M.2 2242 PCB Layout Legend

Label	Connector Type	Function
CN1	Wire to board SMD 2*10P 180° P:2.00mm H:4.0mm	GbE LAN Signal 10/100/1000 LED Signal

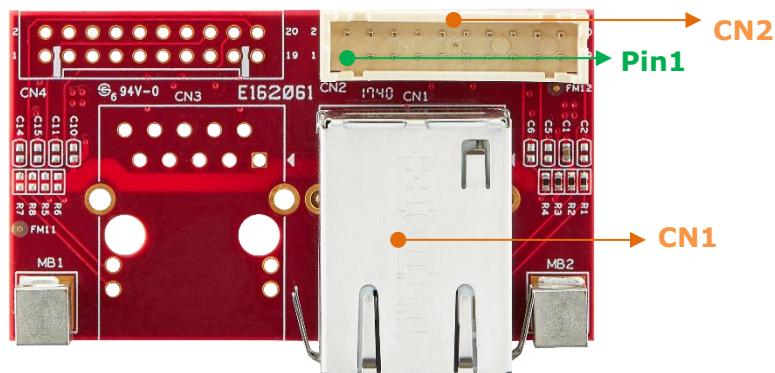


Table 8: Daughter Board PCB Layout Legend

Label	Connector Type	Function
CN1	10/100/1000 Base-T RJ45 PoE DIP 16P16C 90° LED: Green-Orange/Green	PoE GbE LAN Port 10/100/1000 LED Indicator
CN2	Wire to board SMD 2*10P 180° P:2.00mm H:4.0mm	GbE LAN Signal 10/100/1000 LED Signal

2.6.2. Pin Define

Table 9: M.2 B-M Key Pin Define

Signal Name	Pin #	Pin #	Signal Name
		75	NC
3.3V	74	73	GND
3.3V	72	71	GND
3.3V	70	69	NC
NC	68	67	NC

Module Key M

NC	58		
NC	56	57	GND
PE_WAKE_N	54	55	CLK+
GND	52	53	CLK-
PE_RST	50	51	GND
NC	48	49	RX+
NC	46	47	RX-
NC	44	45	GND
NC	42	43	TX+
NC	40	41	TX-
NC	38	39	GND
NC	36	37	NC
NC	34	35	NC
NC	32	33	GND
NC	30	31	NC
NC	28	29	NC
NC	26	27	GND
NC	24	25	NC
NC	22	23	NC
NC	20	21	NC

Module Key B

NC	10	11	GND
NC	8	9	NC
NC	6	7	NC
3.3V	4	5	GND
3.3V	2	3	GND
		1	NC

2.6.3. I/O Connector Mechanical Drawing & Pin Defines

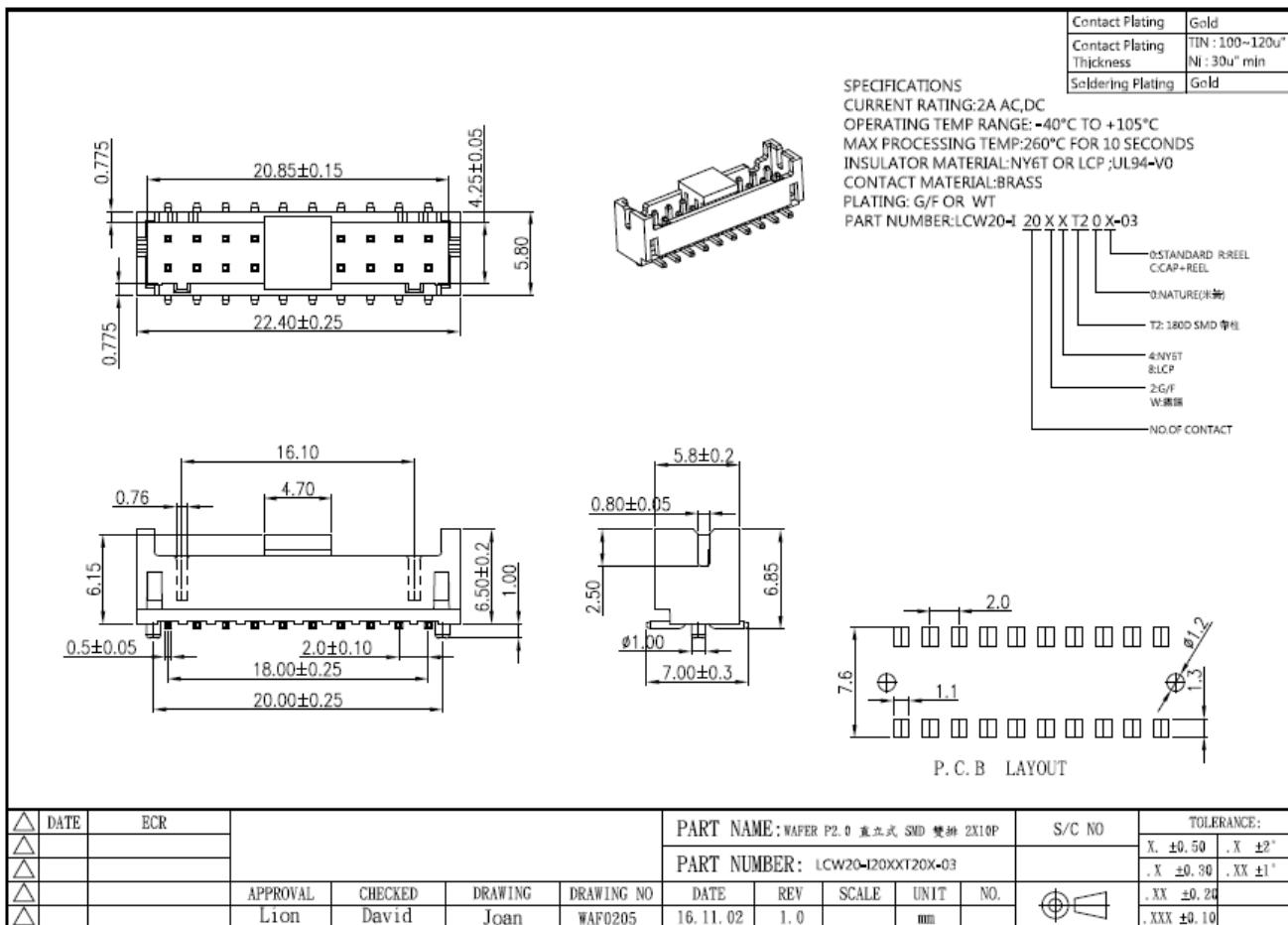


Figure 4: Wire to Board SMD 2*10P Connector Drawing

Table 10: Wire to Board SMD 2*10P Connector Pin Define

Signal Name	Pin #	Pin #	Signal Name
LINK_100_N	2	1	MDIOP_IC
LINK_ACT_N	4	3	MDION_IC
LINK_1000_N	6	5	MDI1P_IC
GND	8	7	MDI1N_IC
GND	10	9	MDI2P_IC
GND	12	11	MDI2N_IC
3.3V	14	13	MDI3P_IC
3.3V	16	15	MDI3N_IC
NC	18	17	NC
NC	20	19	NC

1. MECHANICAL DIMENSION

1.1 Product Dimension

General Tolerance: X.X : ±0.38
X.XX : ±0.20

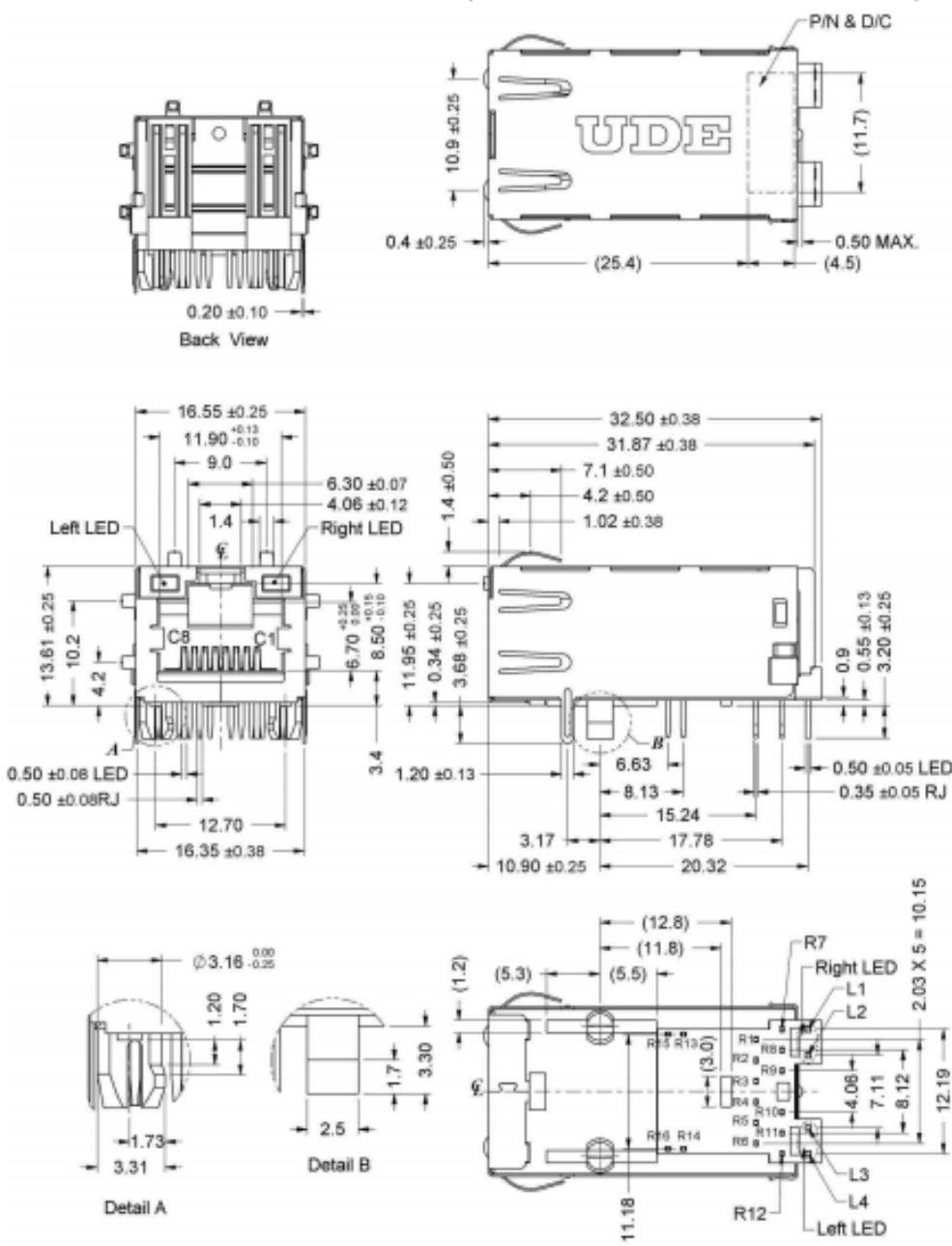
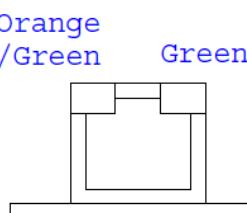
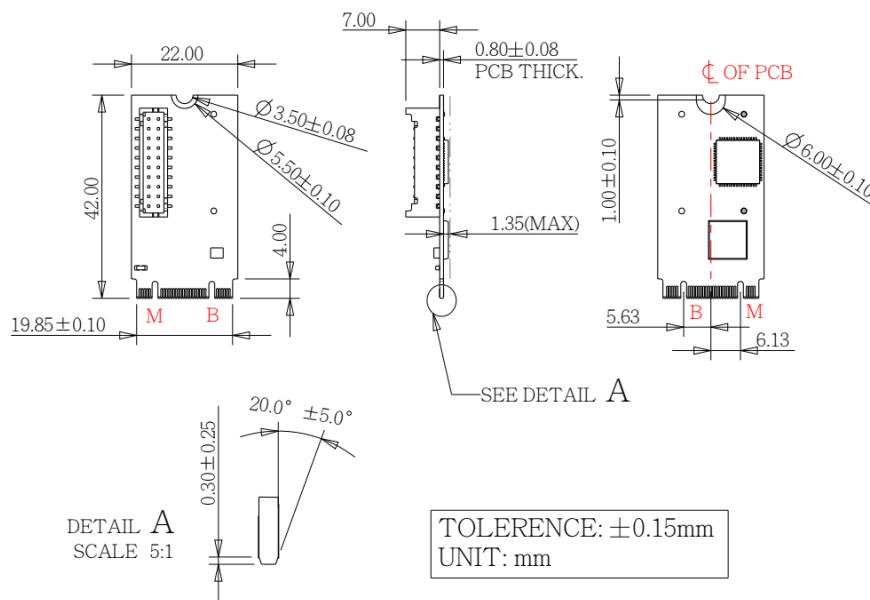
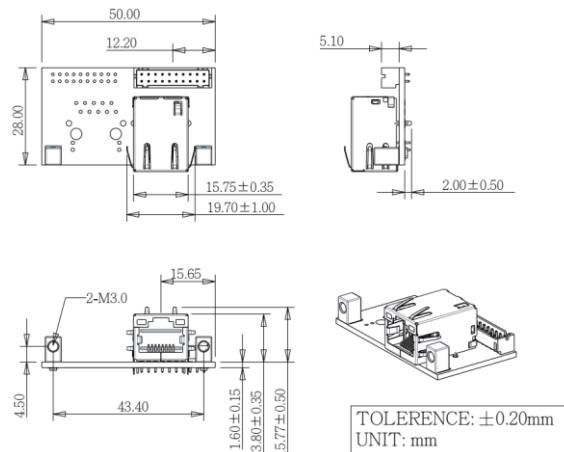


Figure 5: RJ45 Connector Drawing

Table 11: RJ45 LAN LED Table


Speed	Orange/Green (Status)	Green (Active/Link)
10M	OFF	Flash
100M	ON (Green)	Flash
1G	ON (Orange)	Flash

2.6.4. EGLP-G102 Mechanical Drawing**Figure 6: EGLP-G102 M.2 Board Drawing****Figure 7: Mounting Hole Daughter Board Drawing**

2.6.5. Cable Mechanical Drawing

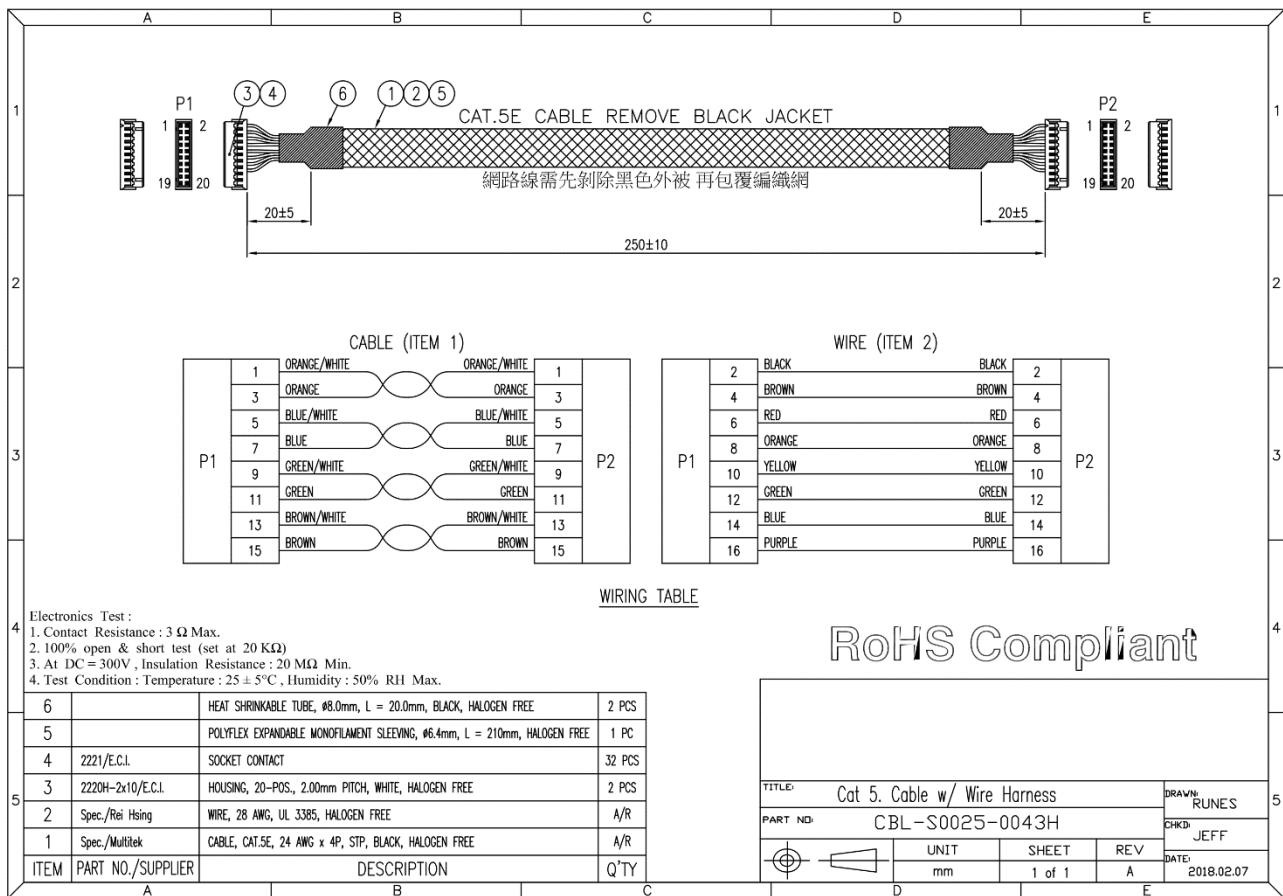


Figure 8: Board to Board LAN Cable Drawing

2.6.6. Packing List

- EGLP-G102 M.2 Board x 1
- EGLP-G102 Daughter Board x 1
- Board to Board LAN Cable x 1

2.7. Software Support

- Windows: XP(32bit), 7(32/64bit), 8/8.1(32/64 bit), 10(32/64bit)
- Linux: Kernel 2.4 above.

3. Installation Guide

Please download driver from Myinnodisk web site.

<https://myinnodisk.innodisk.com/myinnodisk/Login.aspx>

Or you can download intel i210 chip driver from intel official web site directly.

<https://downloadcenter.intel.com/product/64399/Intel-Ethernet-Controller-I210-Series>

4. Appedix



宜鼎國際股份有限公司
Innodisk Corporation
REACH Declaration

Tel:(02)7703-3000 Fax:(02) 7703-3555 Internet: <https://www.innodisk.com/>

Innodisk Corporation pursues its social responsibility for global environmental preservation by committing to be compliant with REACH regulation (REGULATION (EC) No 1907/2006).

We hereby confirm that the product(s),

Scope: Flash Memory, DRAM module and Embedded peripherals products.

- The standard products of not listed in the [Appendix2](#) meet the requirements of REACH SVHC regulations(SVHCs < 0.1% in Article), as described in the candidate list table currently including 211 substances and shown on the ECHA website. (<http://echa.europa.eu/de/candidate-list-table>).
- Contain(s) one or more hazardous substances or constituents exceeding 0.1 % by weight in article if not otherwise specified in candidate list table.
Where the threshold value is exceeded, the substances in question are to be declared in accompanying. (SVHCs > 0.1% in Article).
- Comply with REACH Annex XVII.

Guarantor

Company name 公司名稱 : Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人 : Yichuan Chen 陳怡全

Company Representative Title 公司代表人職稱 : QA Manager 品保經理

Date 日期 : 2021 / 03 / 03

**宜鼎國際股份有限公司
Innodisk Corporation**

Page 1/1

Tel:(02)7703-3000 Internet: <https://www.innodisk.com/>**RoHS 自我宣告書(RoHS Declaration of Conformity)****Manufacturer Products: All Innodisk EM FLASH, DRAM and EP products**

- 一、** 宜鼎國際股份有限公司（以下稱本公司）特此保證售予貴公司之所有產品，皆符合歐盟2011/65/EU 及(EU) 2015/863 關於 RoHS 之規範要求。
 Innodisk Corporation declares that all products sold to the company, are complied with European Union RoHS Directive (2011/65/EU) and (EU) 2015/863 requirement.
- 二、** 本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。
 Innodisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.
- 三、** 本公司聲明我們的產品符合 RoHS 指令的附件中(7a)、(7c-I)允許豁免。
 We declare, our products permitted by the following exemptions specified in the Annex of the RoHS directive.
 ※ (7a) Lead in high melting temperature type solders(i. e. lead-based alloys containing 85% by weight or more lead).
 ※ (7C-I) Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectric devices, or in a glass or ceramic matrix compound.

Name of hazardous substance	Limited of RoHS ppm (mg/kg)
鉛 (Pb)	< 1000 ppm
汞 (Hg)	< 1000 ppm
鎘 (Cd)	< 100 ppm
六價鉻 (Cr 6+)	< 1000 ppm
多溴聯苯 (PBBs)	< 1000 ppm
多溴二苯醚 (PBDEs)	< 1000 ppm
鄰苯二甲酸二(2-乙基己基)酯 (DEHP)	< 1000 ppm
鄰苯二甲酸丁酯苯甲酯 (BBP)	< 1000 ppm
鄰苯二甲酸二丁酯 (DBP)	< 1000 ppm
鄰苯二甲酸二異丁酯 (DIBP)	< 1000 ppm

立 保 證 書 人 (Guarantor)Company name 公司名稱：Innodisk Corporation 宜鼎國際股份有限公司Company Representative 公司代表人：Randy Chien 簡川勝Company Representative Title 公司代表人職稱：Chairman 董事長Date 日期：2020 / 03 / 03

CERTIFICATE OF CONFORMITY

**CE****Product** : M.2 LAN Module**Brand** : Innodisk**Test Model** : E%PL-G#02**Series Model** : E%PL-G#02

(%: Form factor: (2: 2.5"SSD, 3:DDR3 DIMM, D:Dongle, G:NGFF_M.2, H:mPCIe Half, L:PCIe Low profile, M:mPCIe, S:SATA, X:Multi, Z:Others)
#: Output items: (1:1Port, 2:2Ports, 3:3Ports, 4:4Ports, A~Z:Others, X:Multi))

Applicant : Innodisk Corporation**Test Report No.** : CE171206D26

We, Bureau Veritas Consumer Products Services (H.K.) Ltd., Taoyuan Branch, declare that the equipment above has been tested in our facility and found compliance with the requirement limits of applicable standards, in accordance with the Directive 2014/30/EU. The test record, data evaluation and Equipment Under Test (EUT) configurations represented herein are true and accurate under the standards herein specified.

EN 55032:2015 +AC:2016, Class B**EN 61000-3-2:2014 (Not applicable)****EN 61000-3-3:2013 (Not applicable)****EN 55024:2010**

EN 61000-4-2:2009 / IEC 61000-4-2:2008 ED. 2.0

EN 61000-4-3:2006 +A1:2008 +A2:2010 / IEC 61000-4-3:2010 ED. 3.2

EN 61000-4-4:2012 / IEC 61000-4-4:2012 ED. 3.0

EN 61000-4-5:2014 / IEC 61000-4-5:2014 ED. 3.0 (Not applicable)

EN 61000-4-6:2014 / IEC 61000-4-6:2013 ED. 4.0

EN 61000-4-8:2010 / IEC 61000-4-8:2009 ED. 2.0

EN 61000-4-11:2004 / IEC 61000-4-11:2004 ED. 2.0 (Not applicable)

NOTE: The above EN/IEC basic standards are applied with latest version if customer has no special requirement.

Henry Lai / Director

Dec. 18, 2017

No. 47-2, 14th Ling, Chia Pau Vil., Lin Kou Dist., New Taipei City, Taiwan (R.O.C.)

Tel: 886-2-26052180 Fax: 886-2-26051924 <http://www.bureauveritas-adt.com> E-Mail: service.adt@tw.bureauveritas.com

CERTIFICATE OF CONFORMITY



Product : M.2 LAN Module
Brand : Innodisk
Test Model : E%PL-G#02
Series Model : E%PL-G#02
(%: Form factor: (2: 2.5"SSD,3:DDR3 DIMM, D:Dongle, G:NGFF_M.2,
H:mPCIe Half, L:PCIe Low profile, M:mPCIe, S:SATA, X:Multi, Z:Others)
#: Output items: (1:1Port, 2:2Ports, 3:3Ports, 4:4Ports, A~Z:Others, X:Multi))
Applicant : Innodisk Corporation
Report No. : FD171206D26

We, **Bureau Veritas Consumer Products Services (H.K.) Ltd., Taoyuan Branch**, declare that the equipment above has been tested in our facility and found compliance with the requirement limits of applicable standards. The test record, data evaluation and Equipment Under Test (EUT) configurations represented herein are true and accurate under the standards herein specified.

47 CFR FCC Part 15, Subpart B, Class B

ICES-003:2016 Issue 6, Class B

ANSI C63.4:2014

A handwritten signature in blue ink that reads "Henry Lai".

Henry Lai / Director

Dec. 18, 2017

No. 47-2, 14th Ling, Chia Pau Vil., Lin Kou Dist., New Taipei City, Taiwan (R.O.C.)
Tel: 886-2-26052180 Fax: 886-2-26051924
<http://www.bureauveritas-adt.com> E-Mail: service.adt@tw.bureauveritas.com



Contact us

Headquarters (Taiwan)

5F., No. 237, Sec. 1, Datong Rd., Xizhi Dist., New Taipei City 221, Taiwan

Tel: +886-2-77033000

Email: sales@innodisk.com

Branch Offices:

USA

usasales@innodisk.com

+1-510-770-9421

Europe

eusales@innodisk.com

+31-40-3045-400

Japan

jpsales@innodisk.com

+81-3-6667-0161

China

sales_cn@innodisk.com

+86-755-2167-3689

www.innodisk.com

© 2020 Innodisk Corporation.

All right reserved. Specifications are subject to change without prior notice.

February 7, 2022